

LR36683N

Vertical Driver LSI for CCD

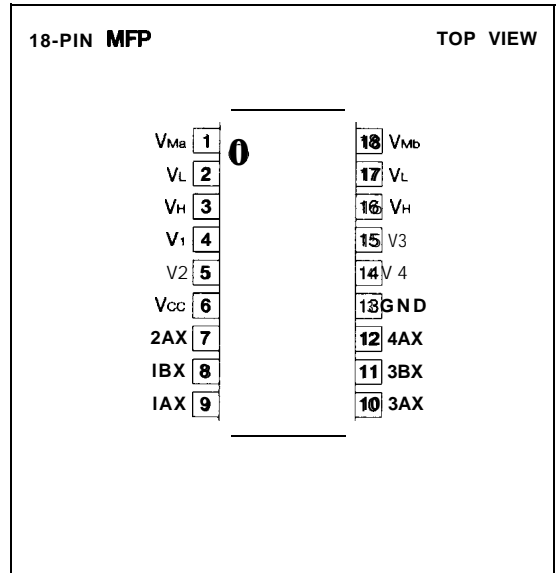
DESCRIPTION

The LR36683N is a vertical clock driver designed for use with CCD area sensors. The driver transforms voltage levels from CMOS level (0 to 5 V) to 27 Vp-p (MAX.) and impedance conversion.

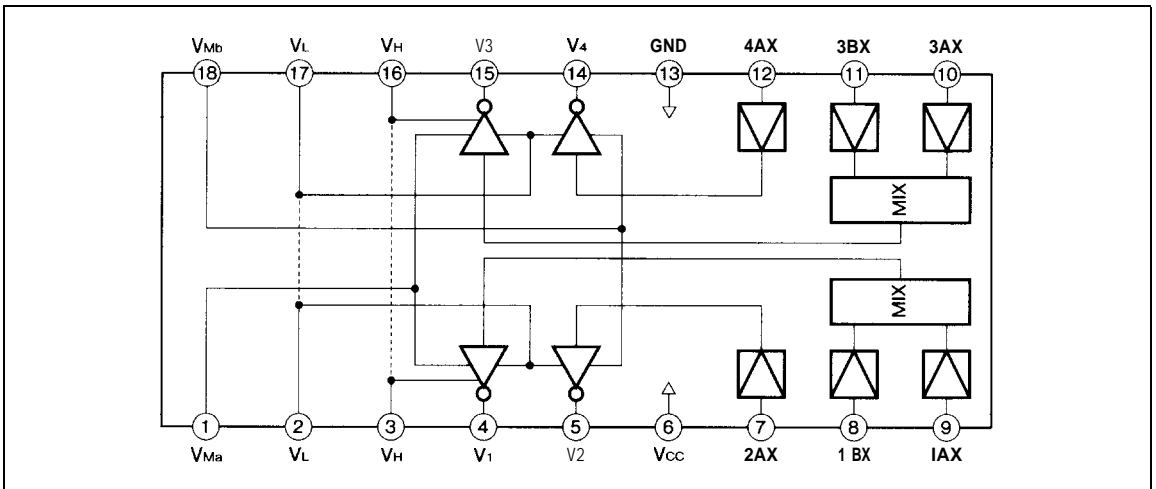
FEATURES

- Two hi-level output circuits
Two tri-level output circuits
- Supply voltage : $V_{CC} = 5.0$ V (TYP.)
 $V_H - V_L = 27$ Vp-p (MAX.)
 $V_H = 20.0$ V (MAX.)
 $V_L = -5.0$ V (MAX.)
 $V_M = 0$ to 4.0 V (independently controllable with bi- or tri-level outputs)
- Switchable between NTSC (EIA) and PAL (CCIR) systems
- Package : 18-pin MFP(MFPOI 8-P)

PIN CONNECTIONS



BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT	NOTE
Supply voltage	V_{CC}	$V_{SS} - 0.3 \text{ V to } V_{SS} + 6.0$	V	1
	$V_H - V_L$	29.0		
	V_{Ma}, V_{Mb}	$V_L \text{ to } V_H$		
Input voltage	V_{IN} 'S3	-0.3 to $V_{CC} + 0.3$	v	
DC load current	I_{OCC}	± 3	mA	
Power dissipation	P_D	300(70°C)	mW	
Storage temperature	T_{STG}	-55 to +150	°C	

NOTE :

1. V_H (MIN.) = V_{CC} , V_L (MAX.) = GND

AC CHARACTERISTICS

($V_{CC} = 5.0 \text{ V}$, $V_H = 15.0 \text{ V}$, $V_L = -9.0 \text{ V}$, $V_{Ma} = V_{Mb} = 0 \text{ to } 4 \text{ V}$, $T_a = -20 \text{ to } 70^\circ\text{C}$)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_M level transition raise delay	t_{TRM}	V_{IN} to $V_L \rightarrow V_M - 1.0 \text{ V}$ Applied to $V_1 - V_4$		800	1200	ns
V_L level transition fall delay	t_{TFL}	V_{IN} to $V_M \rightarrow V_L + 1.0 \text{ V}$ Applied to $V_1 - V_4$		800	1200	ns
V_H level transition raise delay	t_{TRH}	V_{IN} to $V_M \rightarrow V_H - 1.0 \text{ V}$ Applied to V_1 and V_3		800	1200	ns
V_M level transition fall delay	t_{TFM}	V_{IN} to $V_H \rightarrow V_M + 1.0 \text{ V}$ Applied to V_1 and V_3		800	1200	ns
Supply current	I_{DYN}	During operation		9	18	mA

NOTES :

- . The maximum applicable voltage on any pin with respect to GND.
- . Referenced to the "TIMING DIAGRAM"
- . Applied to "EQUIVALENCE CIRCUIT"
- . Applied to "PRECAUTION" 1 and 3.

DC CHARACTERISTICS

($V_{CC} = 5.0 \text{ V}$, $V_H = 15.0 \text{ V}$, $V_L = -9.0 \text{ V}$, $V_{Ma} = V_{Mb} = 0 \text{ to } 4 \text{ V}$, referenced to GND, $T_a = -20 \text{ to } 70^\circ\text{C}$)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Low level input voltage	V_{IL}		0		1.0	v	
High level input voltage	V_{IH}		4.0		5.0	v	
Low level input current	$ I_{IH} $	$V_{IL} = 0 \text{ V}$			1.0	μA	
High level input current	$ I_{IH} $	$V_{IH} = 5 \text{ V}$			1.0	μA	
Low level output voltage	V_{OL}	$I_{OL} < 1 \mu\text{A}$			-8.95	v	
High level output voltage	V_{OH}	$I_{OH} < 1 \mu\text{A}$	14.95			v	2
intermediate level output voltage	V_{OMLa}	$I_{OMLa} < 1 \mu\text{A}$	-0.05			v	2
	V_{OMHa}	$I_{OMHa} < 1 \mu\text{A}$			0.05	v	2
	V_{OMLb}	$I_{OMLb} < 1 \mu\text{A}$	-0.05			v	1
	V_{OMHb}	$I_{OMHb} < 1 \mu\text{A}$			0.05	v	1
Low level output current	I_{OL}	$V_{OL} = V_L + 0.1 \text{ V}$	1.0			mA	
High level output current	I_{OH}	$V_{OH} = V_H - 0.1 \text{ V}$	1.0			mA	2
intermediate -level output current	I_{OMLa}	$V_{OMLa} = V_M - 0.1 \text{ V}$	1.0			mA	2
	I_{OMHa}	$V_{OMHa} = V_M + 0.1 \text{ V}$	1.0			mA	2
	I_{OMLb}	$V_{OMLb} = V_M - 0.1 \text{ V}$	1.0			mA	1
	I_{OMHb}	$V_{OMHb} = V_M + 0.1 \text{ V}$	1.0			mA	1
Output on resistance	R_{ONH}	$I_{OH} = 30 \text{ mA}$		20		Ω	2
	R_{ONM}	$I_{OH} = 30 \text{ mA}$		20		Ω	
	R_{ONL}	$I_{OH} = 30 \text{ mA}$		20		Ω	
Static current	I_{CC}				200	μA	
	I_H				200	μA	
	I_M				200	μA	
	I_L				200	μA	

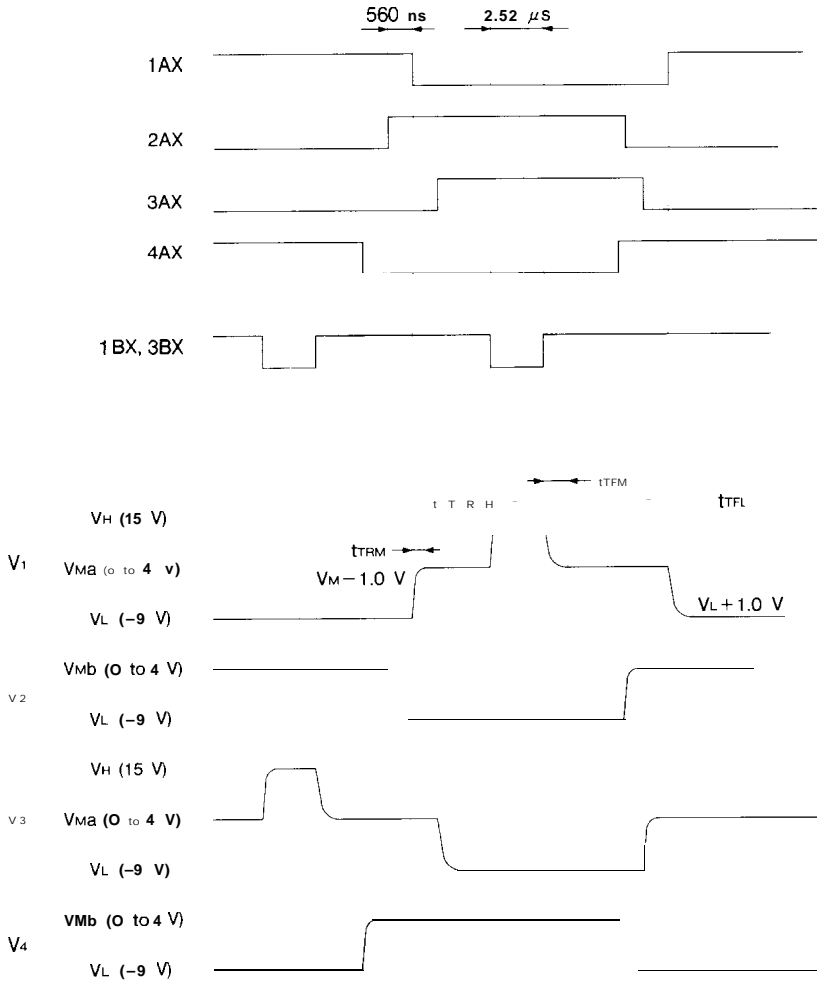
. The current must be specified with the absolute value.

● Applied to "PRECAUTION" 1 and 3.

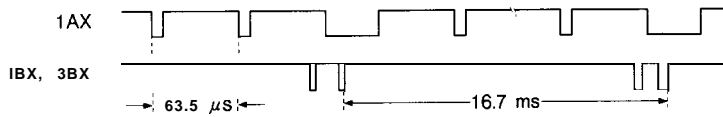
NOTES :

1. Applied to pins v_2 and v_4 .
2. Applied to pins v_1 and v_3 .

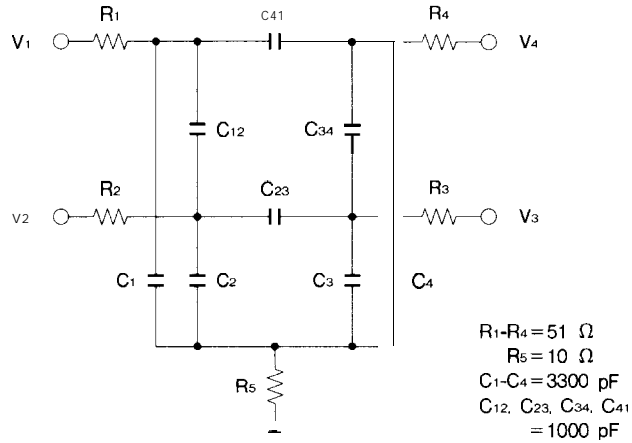
TIMING DIAGRAM



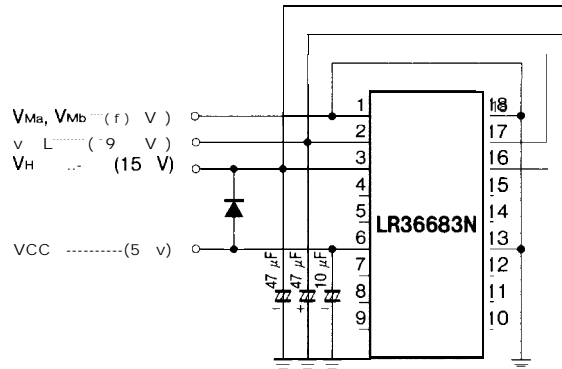
INPUT CYCLE



EQUIVALENCE CIRCUIT



SYSTEM CONFIGURATION EXAMPLE



PRECAUTION

Use this LSI under the following condition 1 and condition 2 or 3.

1. 10 μ F capacitor should be applied between the power supply and GND. (Capacitor is not necessary when V_{Ma} and V_{Mb} are GND level.)
 V_H , V_L , V_{CC} , V_{Ma} , V_{Mb}
2. Diode should be applied between V_{CC} and V_H .
3. Resistor should be applied to pins as below. (Capacitors is not necessary when V_{Ma} and V_{Mb} are GND level.)
 - a) 390 Ω to V_{CC}
 - b) 10 Ω to V_H
 - c) 10 Ω to V_L
 - d) 10 Ω to V_{Ma} and V_{Mb}